

#### **DESCRIPTION**

The SN75176ADR used for RS-485/RS-422 communication is a 10Mbps high-speed transceiver for half duplex communication, which includes one driver Device and a receiver.

Equippedwith ± 8kV human mode ESD protection and failure protection circuit, ensuring that when the receiver input is open or short circuited Receiver output logic high level.

If all transmitters attached to the terminal matching bus are disabled (high resistance), the receiver will output logic high Level.

The SN75176ADR driver does not limit the swing rate and can ensure a communication rate of up to 10Mbps.

SN75176ADR has a receiver with 1 Unit load input impedance, up to 32 transceivers can be connected to the bus.

In addition, SN75176ADR also has an built-in overtemperature protection circuit to ensure the chip is not damaged under high temperature conditions.

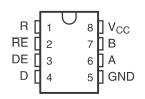
#### **FEATURES**

- · Provide low current shutdown mode
- · Provide industry standard 8-pin SOP packaging
- Up to 32 transceivers are allowed to be mounted on the bus
- · True fail safe receiver compatible with EIA/TIA-485
- Built in over temperature protection circuit ensures that the chip is not damaged due to High temperatures
- Provide enhanced ESD protection for RS-485/ RS-422 A/B pins

#### **APPLICATIONS**

- SCSI "Fast 40" Drivers and Receivers
- · Motor Controller/Position Encoder Systems
- · Factory Automation

#### PIN CONFIGURATION





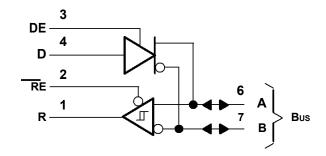
SOP-8(SOIC-8)

#### **Pin Functions**

P	IN	<b>I/O</b>	DESCRIPTION	
NAME	NO.	1/0	DESCRIPTION	
Α	6	Bus input/output	Driver output or receiver input (complementary to B)	
В	7	Bus input/output	Driver output or receiver input (complementary to A)	
D	4	Digital input	Driver data input	
DE	3	Digital input	Active-HIGH driver enable	
GND	5	Reference potential	Local device ground	
R	1	Digital output	Receiver data output	
RE	2	Digital input	Active-LOW receiver enable	
$V_{CC}$	8	Supply	4.75-V to 5.25-V supply	



# **LOGIC DIAGRAM**



# **FEATUER DESCRIPTION**

#### **DRIVER FUNCTION TABLE**

INPUT	ENABLE	OUTPUTS		
D	DE	Α	В	
Н	Н	Н	L	
L	Н	L	Н	
X	L	Z	Z	

H = high level,

L = low level,

X = irrelevant,

Z = high impedance (off)

#### **RECEIVER FUNCTION TABLE**

DIFFERENTIAL INPUTS A-B	EN <u>AB</u> LE RE	OUTPUT R
V <sub>ID</sub> ≥ 0.2 V	L	Н
-0.2 V < V <sub>ID</sub> < 0.2 V	L	?
V <sub>ID</sub> ≤ -0.2 V	L	L
X	Н	Z
Open	L	?

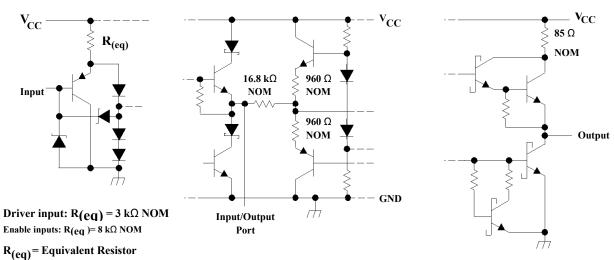
H = high level,

L = low level,

? = indeterminate,

X = irrelevant, Z = high impedance (off)

#### **EQUIVALENT OF EACH INPUT**





## ABSOLUTE MAXIMUM RATINGS

 $(V_{CC} = 5V \pm 5\%, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$ over operating free-air temperature range (unless otherwise noted)1)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V	Supply voltage <sup>(2)</sup>		7	V
	Voltage range at any bus terminal	-10	15	V
VI	Enable input voltage		5.5	V
$\theta_{\scriptscriptstyle JA}$	Package thermal impedance <sup>(3)(4)</sup>		85	°C/W
TJ	Operating virtual junction temperature		150	C
	Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds		260	C
Tstg	Storage temperature range	-65	150	C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- All voltage values, except differential input/output bus voltage, are with respect to network ground terminal.
- (3) Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is PD =  $(T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability. The package thermal impedance is calculated in accordance with JESD 51-7.

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			TYP	MAX	UNIT
$V_{CC}$	Supply voltage		4.75	5	5.25	V
VI or VIC	Valta and the second and the second	-4-l			12	.,
Alor AlC	Voltage at any bus terminal (separately or common mode)				<b>–</b> 7	V
Vih	High-level input voltage	D, DE, and RE	2			V
Vıl	Low-level input voltage	D, DE, and RE			0.8	V
V <sub>ID</sub>	Differential input voltage (1)				±12	V
		Driver			-60	mA
I <sub>OH</sub>	High-level output current	Receiver			-400	μA
		Driver			60	
loL	Low-level output current	Receiver			8	mA
T <sub>A</sub>	Operating free-air temperature		0		70	C

<sup>(1)</sup> Differential input/output bus voltage is measured at the noninverting terminal A, with respect to the inverting terminal B.



## **DRVER SECTION Electrical Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

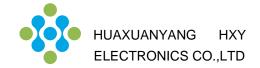
SYMBOL	PARAMETER	TEST CON	DITIONS <sup>(1)</sup>	MIN	TYP <sup>(2)</sup>	MAX	UNIT
$V_{IK}$	Input clamp voltage	I <sub>I</sub> = -18 mA				-1.5	V
VO	Output voltage	IO = 0		0		6	V
VOD1	Differential output voltage	IO = 0		1.5	3.6	6	V
		R <sub>L</sub> = 100 Ω		1/2 V <sub>OD1</sub> or 2 (3)			
VOD2	Differential output voltage	R <sub>L</sub> = 54 Ω		1.5	2.5	5	V
V <sub>OD3</sub>	Differential output voltage	See (4)		1.5		5	V
Δ V <sub>OD</sub>	Change in magnitude of differential output voltage <sup>(5)</sup>	R <sub>L</sub> = 54 Ω or 100 Ω				±0.2	V
Voc	Common-mode output voltage	R <sub>L</sub> = 54 $\Omega$ or 100 $\Omega$				+3 –1	V
Δ VOC	Change in magnitude of common-mode output voltage <sup>(3)</sup>	$R_L$ = 54 $\Omega$ or 100 $\Omega$				±0.2	V
lo	Output current	Output disabled <sup>(6)</sup>	$V_O = 12 V$ $V_O = -7 V$			1 -0.8	mA
Ін	High-level input current	V <sub>I</sub> = 2.4 V				20	μA
<b>I</b> IL	Low-level input current	V <sub>I</sub> = 0.4 V				-400	μA
		V <sub>O</sub> = -7 V				-250	
		V <sub>O</sub> = 0				-150	
los	Short-circuit output current	<b>V - V</b> O CC				250	mA
		V <sub>O</sub> = 12 V				250	
[			Outputs enabled		42	70	
Icc	Supply current (total package)	No load	Outputs disabled		26	35	mA

- (1) The power-off measurement in ANSI Standard TIA/EIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.
- All typical values are at  $V_{CC}$  = 5 V and  $T_A$  = 25°C.
- (3) The minimum V<sub>OD2</sub> with a 100-Ω load is either 1/2 V<sub>OD1</sub> or 2 V, whichever is greater.
   (4) See ANSI Standard TIA/EIA-485-A, Figure 3.5, Test Termination Measurement 2.
- (5) |VOD| and |VOC| are the changes in magnitude of VOD and VOC, respectively, that occur when the input is changed from a high level
- This applies for both power on and off; refer to ANSI Standard TIA/EIA-485-A for exact conditions. The TIA/EIA-422-B limit does not apply for a combined driver and receiver terminal.

# **Switching Characteristics**

 $V_{CC} = 5 \text{ V}, \text{ R}_{\text{I}} = 110 \Omega, \text{ T}_{\text{A}} = 25^{\circ}\text{C} \text{ (unless otherwise noted)}$ 

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{\text{d(OD)}}$	Differential-output delay time	R <sub>L</sub> = 54 Ω		15	22	ns
$t_{t(OD)}$	Differential-output transition time	R <sub>L</sub> = 54 Ω		20	30	ns
$t_{\text{PZH}}$	Output enable time to high level			85	120	ns
t <sub>PZL</sub>	Output enable time to low level			40	60	ns
t <sub>PHZ</sub>	Output disable time from high level			150	250	ns
t <sub>PLZ</sub>	Output disable time from low level			20	30	ns



# Symbol Equivalents

DATA SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
VO	Voa, Vob	Voa, Vob
VOD1	Vo	Vo
V <sub>OD2</sub>	V <sub>t</sub> (R <sub>L</sub> = 100 Ω)	V <sub>t</sub> (R <sub>L</sub> = 54 Ω)
V <sub>OD3</sub>		V <sub>t</sub> (test termination measurement 2)
Δ VOD	$   V_t  -  \overline{V_t}   $	V <sub>t</sub> -   <del>-</del>
Voc	V <sub>os</sub>	V <sub>os</sub>
Δ VOC	$ V_{OS} - \overline{V}_{OS} $	V <sub>OS</sub> - \( \overline{V} \) os
los	I <sub>sa</sub>  ,  I <sub>sb</sub>	
lo	I <sub>xa</sub>  ,  I <sub>xb</sub>	lia, lib

# RECEIVER SECTION Electrical Characteristics

over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP <sup>(1)</sup>	MAX	UNIT
V <sub>IT+</sub>	Positive-going input threshold voltage	$V_0 = 2.7 \text{ V}, I_0 = -0.4$	mA			0.2	V
V <sub>IT-</sub>	Negative-going input threshold voltage	VO= 0.5 V, IO= 8 mA	1	-0.2 <sup>(2)</sup>			V
V <sub>hys</sub>	Input hysteresis voltage (V <sub>IT+</sub> – V <sub>IT</sub> –)				50		mV
Vıĸ	Enable Input clamp voltage	I <sub>I</sub> =–18 mA				-1.5	٧
V <sub>OH</sub>	High-level output voltage	V <sub>ID</sub> = 200 mV, I <sub>OH</sub> =	–400 uA	2.7			V
Vol	Low-level output voltage	V <sub>ID</sub> = -200 mV, I <sub>OL</sub> =	= 8 mA			0.45	V
loz	High-impedance-state output current	V <sub>O</sub> = 0.4 V to 2.4 V				±20	μA
<u> </u>	Line input current	Other input = $0 \sqrt{3}$	V <sub>I</sub> = 12 V			1	mA
lı	Ellio lilpat ourient		V <sub>I</sub> = -7 V			-0.8	1117
Iн	High-level enable input current	V <sub>IH</sub> = 2.7 V				20	μA
<b>I</b> IL	Low-level enable input current	V <sub>IL</sub> = 0.4 V				-100	μA
rı	Input resistance	V <sub>I</sub> = 12 V		12			kΩ
los	Short-circuit output current			-15		-85	mA
			Outputs enabled		42	55	
Icc	Supply current (total package)	No load	Outputs disabled		26	35	mA

<sup>(1)</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# **Switching Characteristics**

 $V_{CC} = 5 \text{ V}, C_L = 15 \text{ pF}, T_A = 25^{\circ}\text{C}$ 

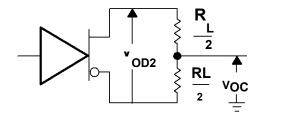
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>t</b> PLH	Propagation delay time, low- to high-level output	Vip = 0 to 3 V		21	35	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	V <sub>ID</sub> = 0 to 3 V		23	35	115
tрzн	Output enable time to high level			10	20	ns
tpzL	Output enable time to low level			12	20	115
<b>t</b> PHZ	Output disable time from high level			20	35	ns
t <sub>PLZ</sub>	Output disable time from low level			17	25	115

<sup>(2)</sup> The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

<sup>(3)</sup> This applies for both power on and power off. Refer to EIA Standard TIA/EIA-485-A for exact conditions.



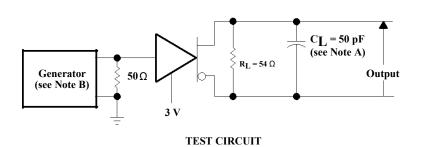
## **Parameter Measurement Information**

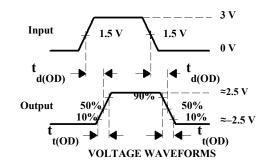


ID VOH OH OH

Figure 1. Driver  $V_{\mbox{\scriptsize OD}}$  and  $V_{\mbox{\scriptsize OC}}$ 

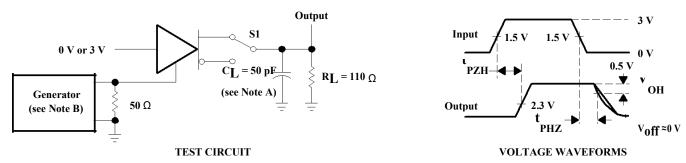
Figure 2. Receiver VOH and VOL





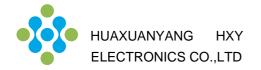
- A. C<sub>L</sub> includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$ 1 MHz, 50% duty cycle,  $t_\Gamma \leq$  6 ns,  $t_f \leq$  6 ns,  $Z_O = 50 \ \Omega$ .

Figure 3. Driver Test Circuit and Voltage Waveforms

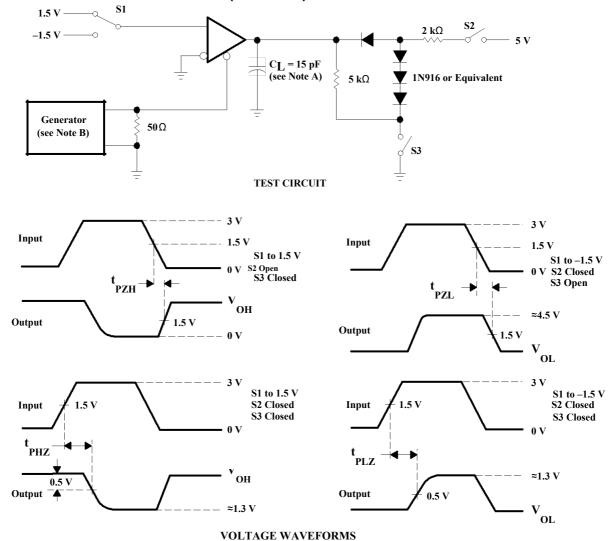


- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$ 1 MHz, 50% duty cycle,  $t_\Gamma \leq$  6 ns,  $t_f \leq$  6 ns,  $t_T \leq$  7 ns,  $t_T \leq$  8 ns,  $t_T \leq$  8 ns,  $t_T \leq$  9 ns,

Figure 4. Driver Test Circuit and Voltage Waveforms

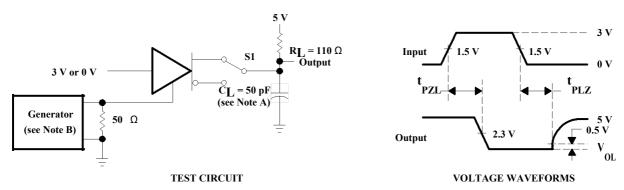


# Parameter Measurement Information (continued)



- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$ 1 MHz, 50% duty cycle,  $t_{\Gamma} \leq$  6 ns,  $t_{f} \leq$  6 ns,  $t_{C} = 50 \Omega$ .

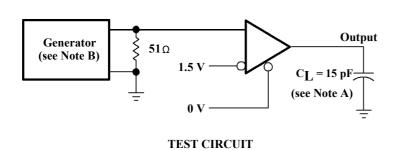
Figure 5. Receiver Test Circuit and Voltage Waveforms

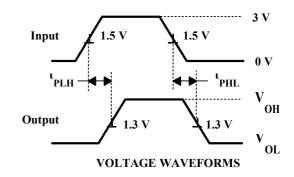


- A. C<sub>L</sub> includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$ 1 MHz, 50% duty cycle,  $t_r \leq$  6 ns,  $t_f \leq$  7 ns,  $t_f \leq$  8 ns,  $t_f \leq$  9 ns,

Figure 6. Driver Test Circuit and Voltage Waveforms







- A. CL includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$ 1 MHz, 50% duty cycle,  $t_{\Gamma} \leq$  6 ns,  $t_{\Gamma} \leq$  7 ns,  $t_{\Gamma} \leq$  8 ns,  $t_{\Gamma} \leq$  8 ns,  $t_{\Gamma} \leq$  8 ns,  $t_{\Gamma} \leq$  9 ns,  $t_{\Gamma} \leq$  9

Figure 7. Receiver Test Circuit and Voltage Waveforms

## TYPOCAL CHARACTERISTICS

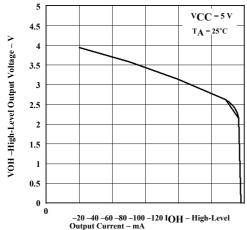


Figure 8. Driver High-Level Output Voltage vs
High-Level Output Current

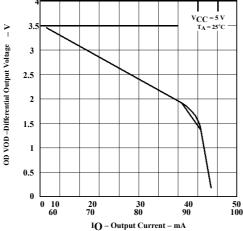


Figure 10. Driver Differential Output Voltage
vs
Output Current

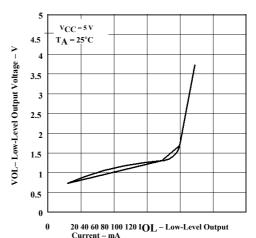
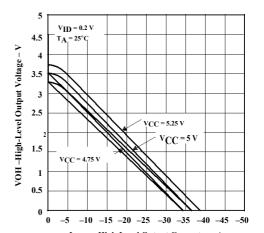


Figure 9. Driver Low-Level Output Voltage vs Low-Level Output Current



IOH – High-Level Output Current – mA
Figure 11. Receiver High-Level Output Voltage
vs
High-Level Output Current

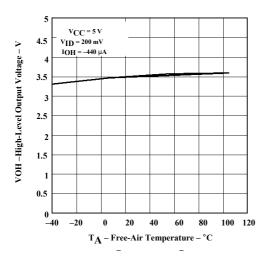


Figure 12. VOH-High-Level Output Voltage vs
Free-Air Temperature

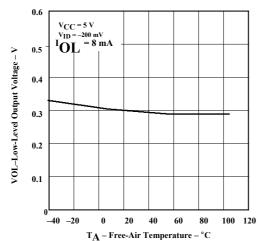


Figure 14. Receiver Low-Level Output Voltage vs
Free-Air Temperature

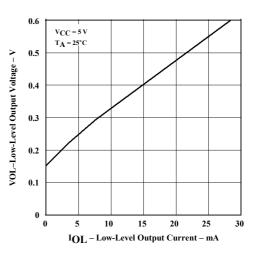
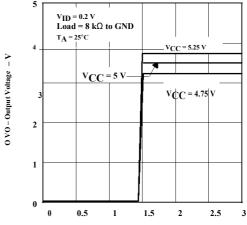
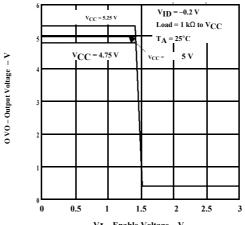


Figure 13. VOL-Low-Level Output Voltage vs
Low -Level Output Current



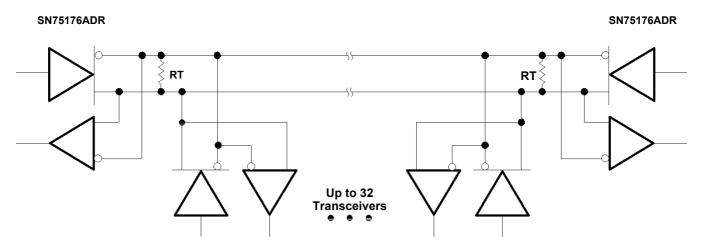
VI – Enable Voltage – V Figure 15. Receiver Output Voltage vs Enable Voltage



VI – Enable Voltage – V Figure 16. Receiver Output Voltage vs Enable Voltage



# **APPLICATION INFORMATION**

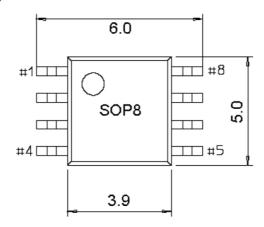


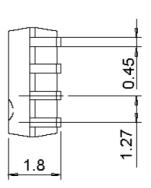
The line should be terminated at both ends in its characteristic impedance ( $R_T = Z_O$ ). Stub lengths off the main line should be kept as short as possible.

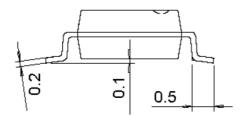
Figure 17. Typical Application Circuit

# **PACKAGE OUTLINE DIMENSIONS**

SOP-8(SOIC-8)









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